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PATENT APPLICATION
Docket No. 11675.184.2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Salman Akram

Serial No.: 10/083,034

Filed: February 26, 2002

Confirmation No.: 3310

For: CHIP PACKAGE WITH GREASE HEAT SINK

Examiner: Leonardo Andújar

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AMENDMENT AND RESPONSE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed from the United States Patent and Trademark Office on June 5, 2003, please enter the following amendments and remarks into the file of the above-identified application.

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